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Quarterly Reliability Monitoring Results

Quarters: Q1/2022 to Q4/2023 Based on structural similarity

Supplier		User Part Number					
Nexperia B.V. Name of Laboratory Assembly reliability labs Based on AEC-Q101 Test		HPZR-C3V9-Q Part Description					
		SMD package					
		Test Conditions	Duration	# Lots	# Quantity	# Rejects	
			TEST				
	Pre- and Post-Stress						
# E1	Electrical Test	Tamb = 25 °C	N/A	see below	all parts	see below	
		JESD22-A113					
		Bake Tamb = 125 °C	24 hours				
	PC	Soak Tamb = 85 °C, RH = 85%	168 hours		64430		
# A1	Preconditioning	Reflow soldering	3 cycles	1514	64430	0	
		MIL-STD-750-1					
	HTRB	M1038 Method A Tj = Tjmax, VR = 80 % of rated reverse					
# B1	Bias	voltage	1000 hours	250	11400	0	
# DI	Did3	5	1000 110015	230	11400	0	
		MIL-STD-750-1 M1038 Method B					
	SSOP	$T_j = T_j max$, $I_z = 100\%$ of max. datasheet					
# B1b	Steady State Operational	reverse current	1000 hours	44	1920	0	
" 010	,		1000 110013		1920	0	
	тс	JESD22-A104					
# A4	Temperature Cycling	-65 °C to Timax, not to exceed 150°C	1000 cycles	311	14080	0	
	UHAST	JESD22-A118					
# A3 or	Unbiased HAST	Tamb = 130 °C, RH = 85 %	— 96 hours	311	14080	0	
		JESD22-A102	96 nours				
	AC	Tamb = 121 °C, RH = 100 %					
# A3 alt	Autoclave	Pressure = 205 kPa (29.7 psia)					
	H3TRB	JESD22-A101					
	High Humidity High	Tamb = 85 °C, RH = 85%, VR = 80 % of					
# A2 alt	Temperature Reverse Bias	rated reverse voltage ^{L1J}	1000 hours	311	14080	0	
		MIL-STD-750 Method 1037					
	IOL	ton = toff, devices powered to insure $\Delta T j$ =					
# A5	Intermittent Operating Life	100 °C for 15000 cycles	1000 hours	312	14120	0	
	RSH	JESD22-A111					
# C8	Resistance to Solder Heat	260 °C ± 5 °C	10 s	269	8070	0	
	SD Coldershilith	1 CTD 002		10			
# C10	Solderability	J-STD-002		19	6660	0	

[1] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

Calculation of FIT and MTTF

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1) Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

Wafer Fab	Technology	Quantity	Rejects	Failure Rate (FIT)	MTTF (hrs)
Nexperia					
DHAM	Zener	11400	0	0,37	2,68E+09
	201101	11.00		6,67	2,002.10

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